

Electronic Patent Application Fee Transmittal

Application Number:	10797876			
Filing Date:	10-Mar-2004			
Title of Invention:	Silicon germanium surface layer for high-k dielectric integration			
First Named Inventor/Applicant Name:	Anthony Dip			
Filer:	Kevin E. Kuehn/Diane Attix			
Attorney Docket Number:	TPS-007			
Filed as Large Entity				
Utility under 35 USC 111(a) Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Notice of appeal	1401	1	540	540
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				540